# PEMD3; PIMD3; PUMD3

# NPN/PNP resistor-equipped transistors; R1 = 10 k $\Omega$ , R2 = 10 k $\Omega$

Rev. 11 — 25 September 2013

**Product data sheet** 

## 1. Product profile

#### 1.1 General description

NPN/PNP Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

Type number	ımber Package		PNP/PNP	NPN/NPN	Package
	Nexperia	JEITA	complement	complement	configuration
PEMD3	SOT666	-	PEMB11	PEMH11	ultra small and flat lead
PIMD3	SOT457	SC-74	-	-	small
PUMD3	SOT363	SC-88	PUMB11	PUMH11	very small

#### 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
  - Reduces pick and place costs
  - AEC-Q101 qualified

#### 1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	stor; for the PNP transistor	(TR2) with negative	ve polarity			
$V_{CEO}$	collector-emitter voltage	open base	-	-	50	V
Io	output current		-	-	100	mA
R1	bias resistor 1 (input)		7	10	13	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	



## 2. Pinning information

Table 3. Pinning

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	GND (emitter) TR1		
2	input (base) TR1	6   5   4	6 5 4
3	output (collector) TR2		
4	GND (emitter) TR2		R1 R2
5	input (base) TR2		TR1
6	output (collector) TR1	001aab555	R2 R1
			006aaa143

## 3. Ordering information

Table 4. Ordering information

Type number	Package				
	Name	Description	Version		
PEMD3	-	plastic surface-mounted package; 6 leads	SOT666		
PIMD3	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457		
PUMD3	SC-88	plastic surface-mounted package; 6 leads	SOT363		

## 4. Marking

Table 5. Marking codes

Type number	Marking code <sup>[1]</sup>
PEMD3	D3
PIMD3	M7
PUMD3	D*3

<sup>[1] \* =</sup> placeholder for manufacturing site code.

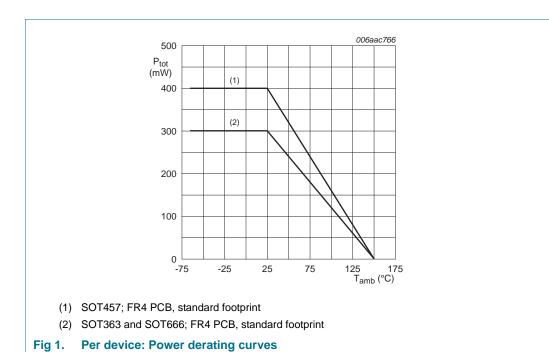
## 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

0	Danamatan	0	, A4!	NA	1111
Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	tor; for the PNP transistor	(TR2) with negative	oolarity		
$V_{CBO}$	collector-base voltage	open emitter	-	50	V
$V_{CEO}$	collector-emitter voltage	open base	-	50	V
$V_{EBO}$	emitter-base voltage	open collector	-	10	V
$V_{I}$	input voltage TR1				
	positive		-	+40	V
	negative		-	-10	V
	input voltage TR2				
	positive		-	+10	V
	negative		-	-40	V
Io	output current		-	100	mA
I <sub>CM</sub>	peak collector current		-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	[1]		
	PEMD3 (SOT666)		-	200	mW
	PIMD3 (SOT457)		-	250	mW
	PUMD3 (SOT363)		-	200	mW
Per device					
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	<u>[1]</u>		
	PEMD3 (SOT666)		-	300	mW
	PIMD3 (SOT457)		-	400	mW
	PUMD3 (SOT363)		-	300	mW
T <sub>j</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

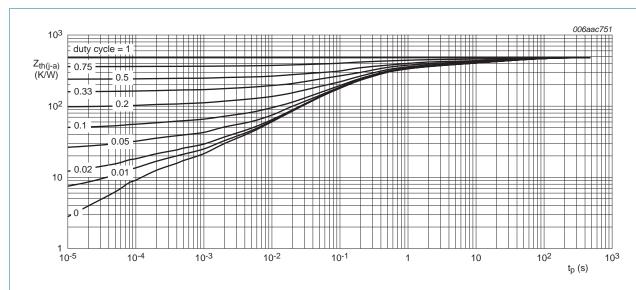


## 6. Thermal characteristics

Table 7. Thermal characteristics

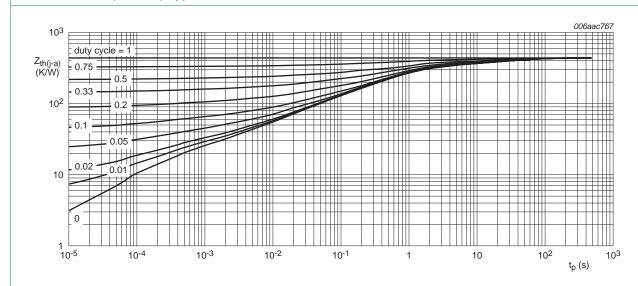
	Titorinai oriai aotoriotio	•				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	sistor					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	PEMD3 (SOT666)		-	-	625	K/W
	PIMD3 (SOT457)		-	-	500	K/W
	PUMD3 (SOT363)		-	-	625	K/W
Per devid	ce					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	PEMD3 (SOT666)		-	-	417	K/W
	PIMD3 (SOT457)		-	-	313	K/W
	PUMD3 (SOT363)		-	-	417	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



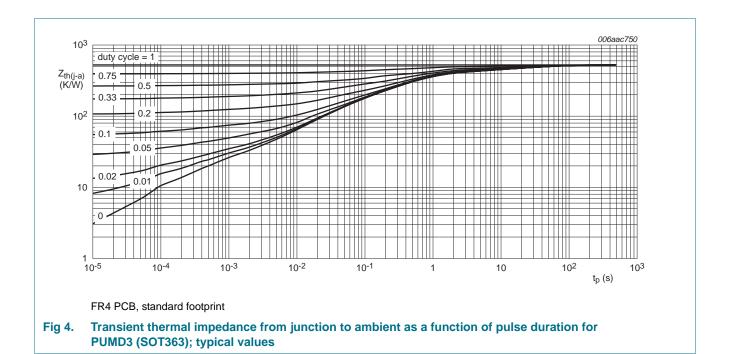
FR4 PCB, standard footprint

Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration for PEMD3 (SOT666); typical values



FR4 PCB, standard footprint

Fig 3. Transient thermal impedance from junction to ambient as a function of pulse duration for PIMD3 (SOT457); typical values



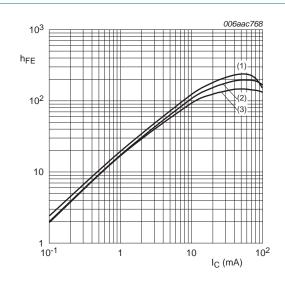
## 7. Characteristics

Table 8. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor; for the PNP tran	sistor (TR2) with negative p	olarity			
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
I <sub>CEO</sub>	collector-emitter	$V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A}$	-	-	1	μΑ
	cut-off current	$V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A};$ $T_{j} = 150 ^{\circ}\text{C}$	-	-	5	μА
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$	-	-	400	μА
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	30	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	-	-	150	mV
$V_{I(off)}$	off-state input voltage	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$	-	1.1	0.8	V
$V_{I(on)}$	on-state input voltage	$V_{CE} = 0.3 \text{ V; } I_{C} = 10 \text{ mA}$	2.5	1.8	-	V
R1	bias resistor 1 (input)		7	10	13	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz				
	TR1 (NPN)		-	-	2.5	pF
	TR2 (PNP)		-	-	3	pF
f <sub>T</sub>	transition frequency	$V_{CB} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz	[1]			
	TR1 (NPN)		-	230	-	MHz
	TR2 (PNP)		-	180	-	MHz

<sup>[1]</sup> Characteristics of built-in transistor.



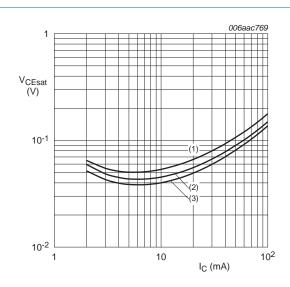
$$V_{CE} = 5 \text{ V}$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 5. TR1 (NPN): DC current gain as a function of collector current; typical values



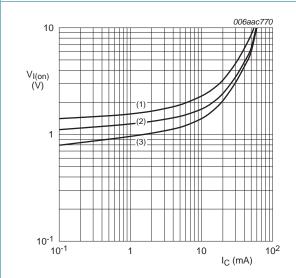
$$I_{\rm C}/I_{\rm B} = 20$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 6. TR1 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



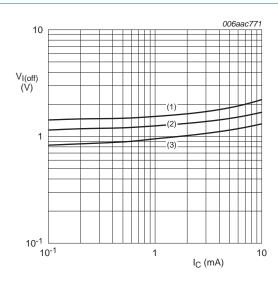
$$V_{CE} = 0.3 \text{ V}$$

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 7. TR1 (NPN): On-state input voltage as a function of collector current; typical values



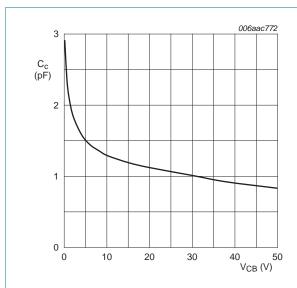
$$V_{CE} = 5 V$$

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

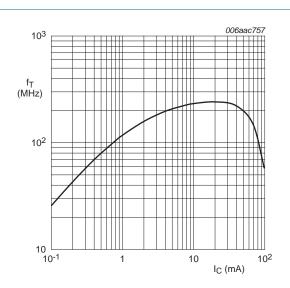
(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 8. TR1 (NPN): Off-state input voltage as a function of collector current; typical values



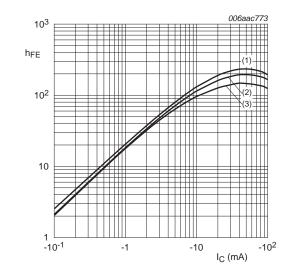
f = 1 MHz; T<sub>amb</sub> = 25 °C

Fig 9. TR1 (NPN): Collector capacitance as a function of collector-base voltage; typical values



 $V_{CE} = 5 \text{ V}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig 10. TR1 (NPN): Transition frequency as a function of collector current; typical values of built-in transistor

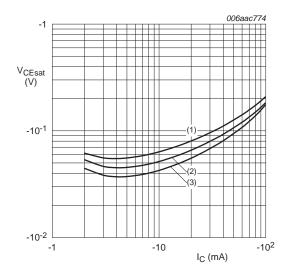


$$V_{CE} = -5 \text{ V}$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(3) 
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 11. TR2 (PNP): DC current gain as a function of collector current; typical values



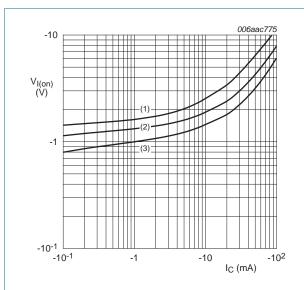
$$I_{\rm C}/I_{\rm B} = 20$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -40 \, ^{\circ}C$$

Fig 12. TR2 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values



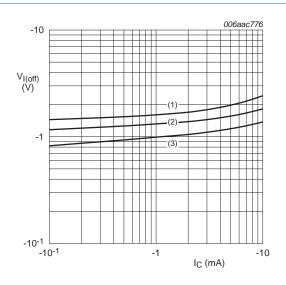
$$V_{CE} = -0.3 \text{ V}$$

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 13. TR2 (PNP): On-state input voltage as a function of collector current; typical values



$$V_{CE} = -5 \text{ V}$$

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 14. TR2 (PNP): Off-state input voltage as a function of collector current; typical values

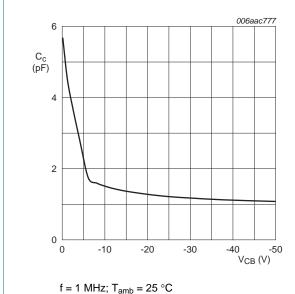
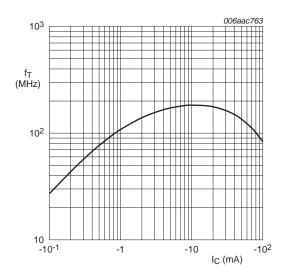


Fig 15. TR2 (PNP): Collector capacitance as a function of collector-base voltage; typical values



 $V_{CE}$  = -5 V;  $T_{amb}$  = 25 °C

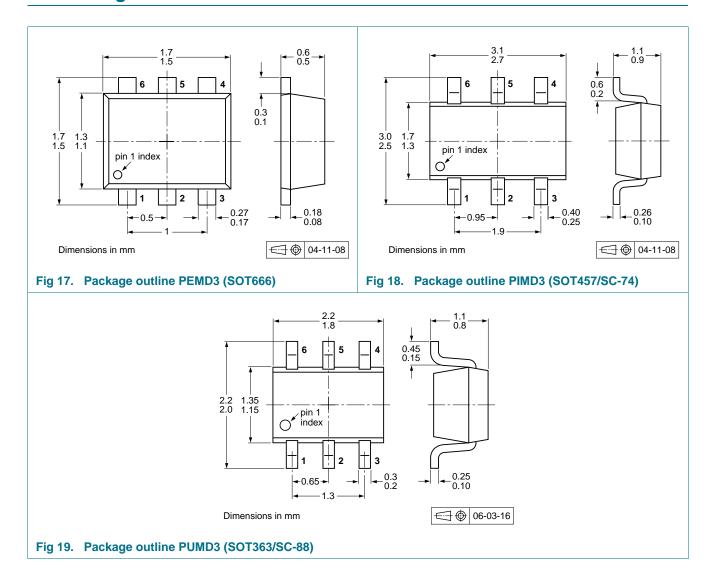
Fig 16. TR2 (PNP): Transition frequency as a function of collector current; typical values of built-in transistor

## 8. Test information

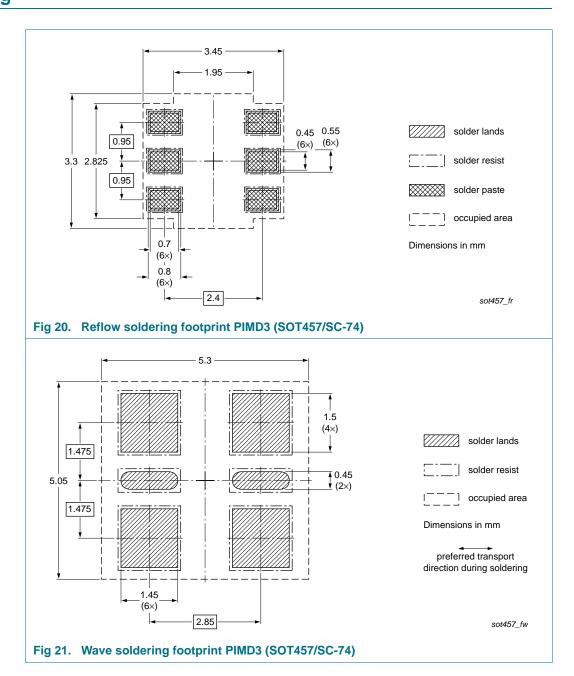
#### 8.1 Quality information

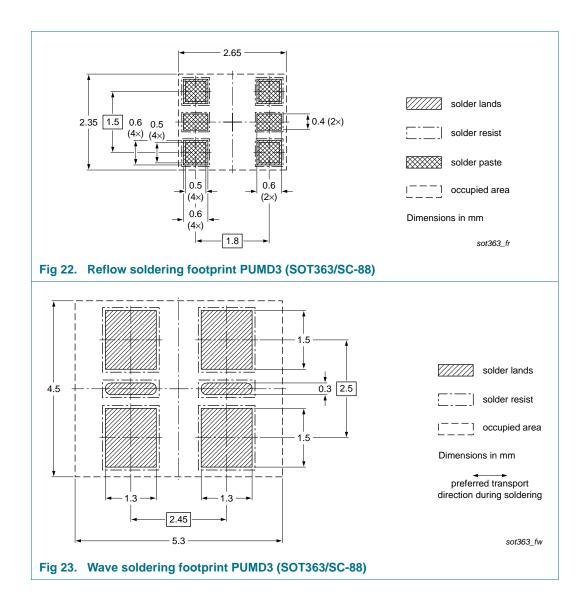
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

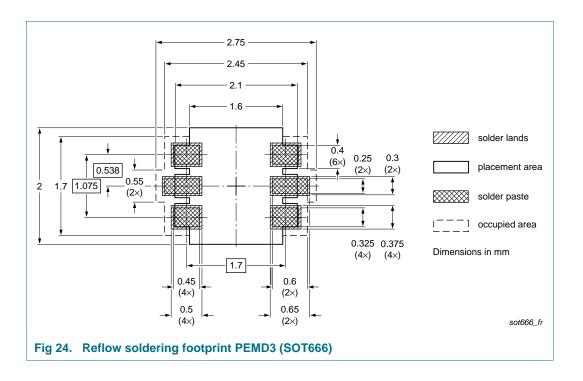
## 9. Package outline



## 10. Soldering







## 11. Revision history

#### Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
PEMD3_PIMD3_ PUMD3 v.11	20130925	Product data sheet	-	PEMD3_PIMD3_ PUMD3 v.10			
Modifications:	<ul> <li>Section 1 "P</li> </ul>	roduct profile": updated					
	<ul> <li>Section 4 "N</li> </ul>	Marking": updated					
	<ul> <li>Table 6 "Lim</li> </ul>	iting values": Ptot updated	according to the la	test measurements			
	• Table 7 "The	ermal characteristics": upda	ited according to th	ne latest measurements			
	• Table 8 "Cha	aracteristics": I <sub>CEO</sub> updated	according to the la	atest measurements, $f_T$ added			
	• Figure 1 to 3	3, 9, 10, 15 and 16: added					
	• <u>Figure 5</u> to 8	and Figure 11 to 14: upda	ited				
	Section 8 "Test information": added						
	<ul><li>Section 10 "</li></ul>	Soldering": added					
	<ul><li>Section 12 "</li></ul>	Legal information": updated	d				
PEMD3_PIMD3_	20091115	Product data sheet	-	PEMD3_PIMD3_			
PUMD3 v.10				PUMD3 v.9			
PEMD3_PIMD3_ PUMD3 v.9	20050518	Product data sheet	-	PEMD3_PIMD3_			
				PUMD3 v.8			
PEMD3_PIMD3_ PUMD3 v.8	20041206	Product data sheet	-	PEMD3_PUMD3 v.7			

### 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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PEMD3\_PIMD3\_PUMD3

## PEMD3; PIMD3; PUMD3

#### **NPN/PNP** resistor-equipped transistors

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# PEMD3; PIMD3; PUMD3

## **Nexperia**

NPN/PNP resistor-equipped transistors

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